VSMB2943RGX01, VSMB2943GX01

• Dimensions (L x W x H in mm): 2.3 x 2.3 x 2.55



Vishay Semiconductors

High Speed Infrared Emitting Diodes, 940 nm, GaAIAs, MQW

FEATURES

 Package type: surface mount · Package form: GW, RGW

Peak wavelength: λ_p = 940 nm

• Angle of half intensity: $\varphi = \pm 25^{\circ}$



DESCRIPTION

VSMB2943X01 series are infrared, 940 nm emitting diodes in GaAlAs multi quantum well (MQW) technology with high radiant power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

APPLICATIONS

- IrDA compatible data transmission
- Miniature light barrier
- · IR touch panels
- 3D TV
- Photointerrupters
- · Optical switch
- · Control and drive circuits
- Shaft encoders

PRODUCT SUMMARY

COMPONENT	l _e (mW/sr)	φ (deg)	λ _p (nm)	t _r (ns)
VSMB2943RGX01	20	± 25	940	15
VSMB2943GX01	20	± 25	940	15

Note

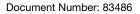
Test conditions see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
VSMB2943RGX01	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Reverse gullwing	
VSMB2943GX01	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Gullwing	

Note

MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V _R	5	V
Forward current		I _F	100	mA
Peak forward current	$t_p/T = 0.5, t_p = 100 \ \mu s$	I _{FM}	200	mA
Surge forward current	t _p = 100 μs	I _{FSM}	1	A
Power dissipation		Pv	160	mW
Junction temperature		Тj	100	°C
Operating temperature range		T _{amb}	-40 to +85	°C
Storage temperature range		T _{stg}	-40 to +100	°C
Soldering temperature	according figure 9, J-STD-020	T _{sd}	260	°C
Thermal resistance junction/ambient	J-STD-051, leads 7 mm, soldered on PCB	R _{thJA}	250	K/W





GREEN (5-2008)

· Low forward voltage

AEC-Q101 qualified

· High radiant power

· High radiant intensity

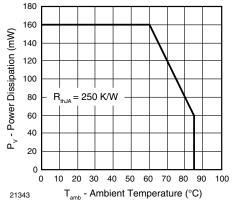
· High reliability

- · Suitable for high pulse current operation
- · Terminal configurations: gullwing or reserve gullwing
- Package matches with detector VEMD2xx3X01 and VEMT2xx3X01 series
- Floor life: 4 weeks, MSL 2a, acc. J-STD-020
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

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Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

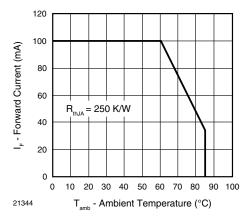


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	V _F	1.15	1.35	1.6	V
	I _F = 1 A, t _p = 100 μs	V _F		2.2		V
Temperature coefficient of V_{F}	I _F = 1 mA	TK _{VF}		-1.8		mV/K
	I _F = 100 mA	TK _{VF}		-1.1		mV/K
Reverse current		I _R	Not designed for reverse operation		μA	
Junction capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0 mW/cm^{2}$	CJ		70		pF
Radiant intensity	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	l _e	10	20	30	mW/sr
	I _F = 1 A, t _p = 100 μs	l _e		170		mW/sr
Radiant power	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	фе		40		mW
Temperature coefficient of radiant power	I _F = 1 mA	ΤΚφ _e		-1.1		%/K
	I _F = 100 mA	ΤΚφ _e		-0.51		%/K
Angle of half intensity		φ		± 25		deg
Peak wavelength	I _F = 30 mA	λ _p	920	940	960	nm
Spectral bandwidth	I _F = 30 mA	Δλ		25		nm
Temperature coefficient of λ_p	I _F = 30 mA	ΤΚλρ		0.25		nm/K
Rise time	$I_F = 100 \text{ mA}, 20 \% \text{ to } 80 \%$	tr		15		ns
Fall time	$I_F = 100 \text{ mA}, 20 \% \text{ to } 80 \%$	t _f		15		ns
Cut-off frequency	$I_{DC} = 70 \text{ mA}, I_{AC} = 30 \text{ mA pp}$	f _c		23		MHz



VSMB2943RGX01, VSMB2943GX01

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BASIC CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)

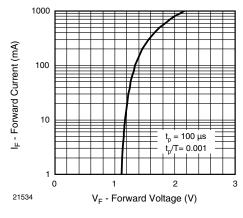


Fig. 3 - Forward Current vs. Forward Voltage

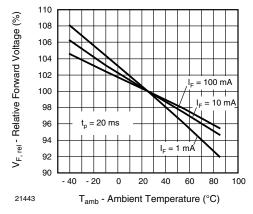


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

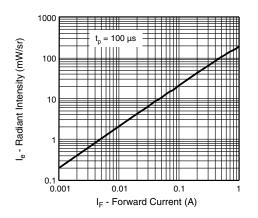


Fig. 5 - Radiant Intensity vs. Forward Current

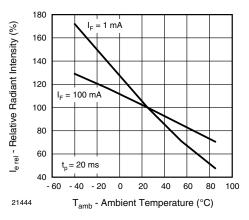


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

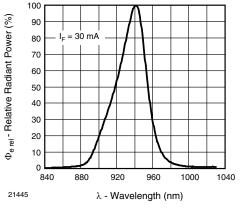


Fig. 7 - Relative Radiant Power vs. Wavelength

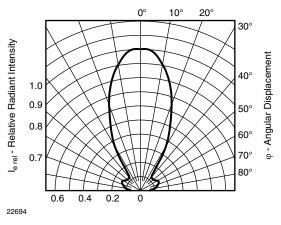


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

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Document Number: 83486

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VSMB2943RGX01, VSMB2943GX01

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during

transportation and storage. Each bag contains a desiccant.

Floor life (time between soldering and removing from MBB)

In case of moisture absorption devices should be baked

before soldering. Conditions see J-STD-020 or label.

Devices taped on reel dry using recommended conditions

must not exceed the time indicated on MBB label:

Moisture sensitivity level 2a, acc. to J-STD-020.

Conditions: T_{amb} < 30 °C, RH < 60 %

192 h at 40 °C (+ 5 °C), RH < 5 %.

DRYPACK

FLOOR LIFE

Floor life: 4 weeks

DRYING

Vishay Semiconductors

SOLDER PROFILE

ISHA

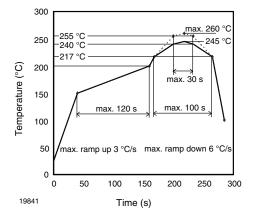
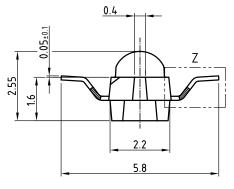
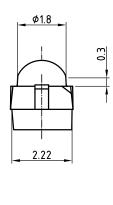
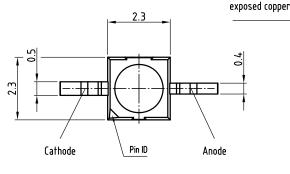


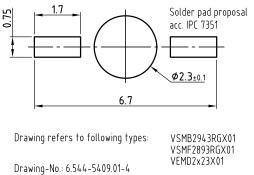
Fig. 9 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

PACKAGE DIMENSIONS in millimeters: VSMB2943RG









Issue: prel. 03.08.12

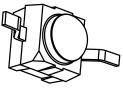
Z 20:1



0.8

Dimensions in mm

Not indicated tolerances ±0.2



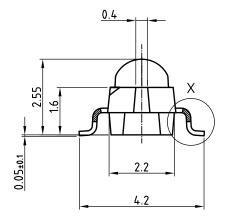
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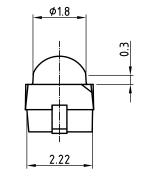
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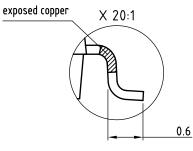
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PACKAGE DIMENSIONS in millimeters: VSMB2943G

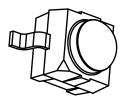


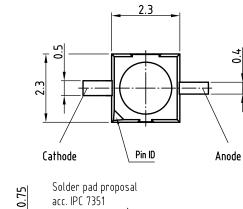


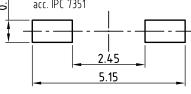




Dimensions in mm Not indicated tolerances ±0.2







Drawing refers to following types: VSMB2943GX01 VSMF2893GX01 VEMD2x23X01 Drawing-No.: 6.544-5408.01-4 Issue: prel; 03.08.12

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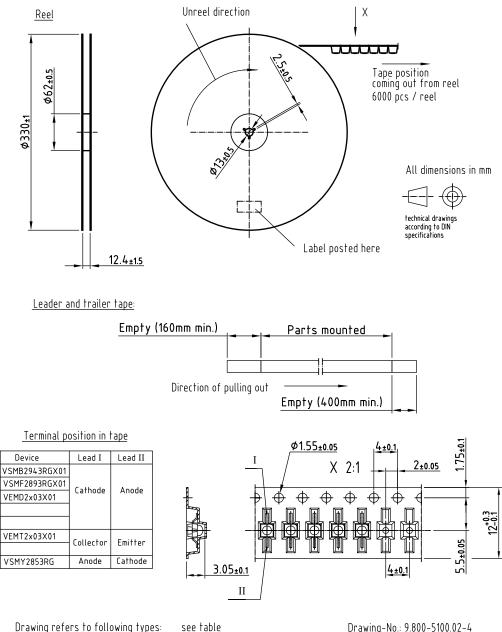
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0.4

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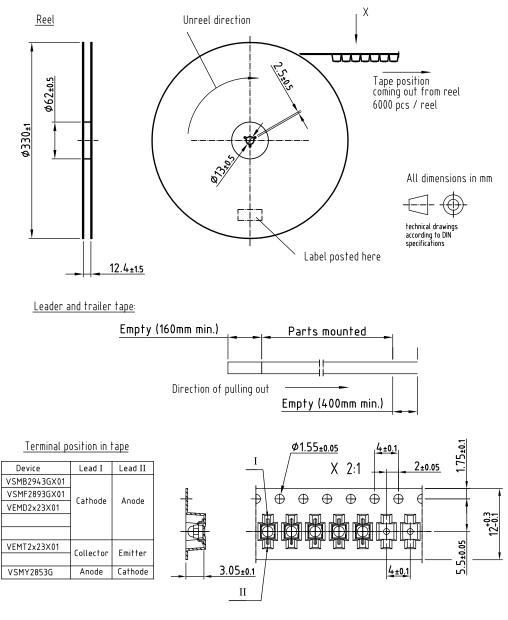
TAPING AND REEL DIMENSIONS in millimeters: VSMB2943RG



Drawing refers to following types: Reel dimensions and tape Drawing-No.: 9.800-5100.02-4 Issue: prel; 03.08.12



TAPING AND REEL DIMENSIONS in millimeters: VSMB2943G



Drawing refers to following types: see table Reel dimensions and tape Drawing-No.: 9.800-5091.21-4 Issue: prel; 03.08.12



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